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## Anti-Surge Low-Resistance Metal Film Chip Resistor — TGL Series



## Application

- Consumer electronics
- Computer & relative products
- Communication devices
- Measuring instrument
- Industrial / Power supply
- Battery management system

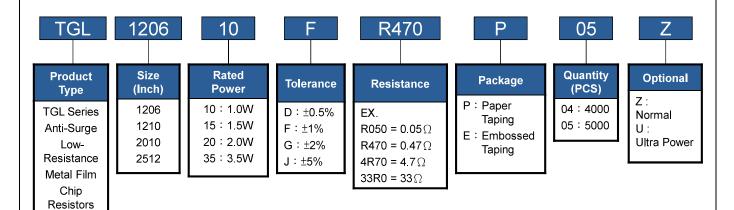
### Features

**Bottom view** 

- Low Resistance / TCR / Inductance(≤5nH)
- Excellent long-term stability
- High precision current sensing
- High rated power capability and excellent Anti-Surge
- Halogen free and lead free
- RoHs compliant

#### Parts Number Explanation

#### Example:





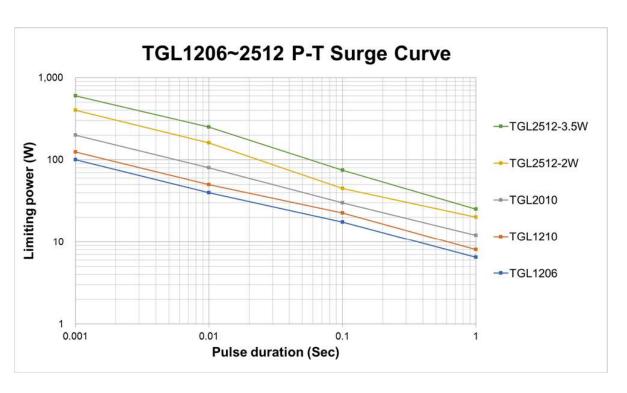
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# Standard Electrical Specifications

<b>T</b>	Rated	Max. Rated	Max. T.C.R.		Resistance Range
Туре	Power at 70°C	Current	Overload Current	(ppm/°C)	D(0.5%), F(1.0%), G(2.0%), J(5.0%)
TGL1206	1W	4.47A	10.00A	±100	$50 \text{ m}\Omega \leq R < 100 \text{ m}\Omega$
TGL1210	1W	4.47A	10.00A	±50	$100$ mΩ $\leq$ R $\leq$ 33 Ω
TGL2010	1.5W	5.48A	12.25A		5
TOL 2542	2W	6.32A	14.14A	±50	$50~\text{m}\Omega~\leq~R~\leq~50~\Omega$
TGL2512	3.5W(U)	8.37A	18.71A		

- For non-standard parts, please contact our sales dept.
- Operating Temperature Range : −55°C~+170°C.

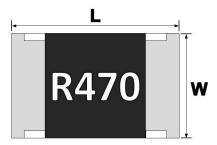
# Anti-Surge Ability:

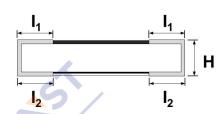




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# ■ Type Dimension

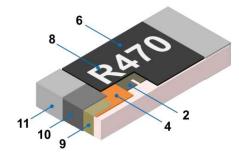


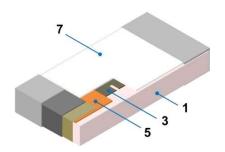


Unit: mm

TYPE	L	W		l <sub>1</sub>	2
TGL1206	3.10±0.10	1.60±0.10	0.55±0.10	0.40±0.20	0.45±0.20
TGL1210	3.10±0.10	2 <mark>.5</mark> 0±0.15	0.55±0.10	0.50±0.20	0.50±0.20
TGL2010	5.00±0.20	2. <mark>50</mark> ±0.15	0.55±0.10	0.60±0.25	0.60±0.25
TGL2512	6.30±0.20	3.20±0.20	0.55±0.10	0.65±0.25	0.65±0.25
TGL2512(U)	6.30±0.20	3.20±0.20	0.70±0.15	0.65±0.25	0.65±0.25

# Construction





1	Alumina Substrate	7	Bottom Protective Overcoat
2	Top Resistive Layer	8	Marking
3	Bottom Resistive Layer	9	Side Inner Electrode
4	Top Inner Electrode (Cu)	10	Barrier Layer (Ni)
5	Bottom Inner Electrode (Cu)	11	Solder coating (Sn)
6	Top Protective Overcoat	ı	_



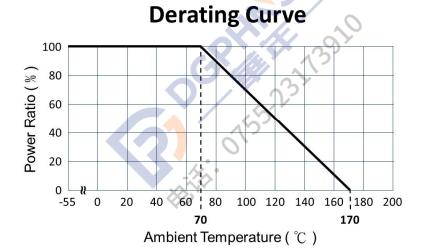
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#### Performance Characteristics

#### Power Derating Curve

The Operating Temperature Range: -55°C ~+170°C.

Power rating or current rating is in the case based on continuous full-load at ambient temperature of 70°C. For operation at ambient temperature in excess of 70°C, the load should be derated in accordance with figure of derating Curve.



#### Rated Current

Resistance Range: < 10

Rated Current: The resistor shall have a DC continuous working current or a AC (rms) continuous working current at commercial-line frequency and wave form corresponding to the power rating, as determined formula as following:

I = Rated current (A)
$$P = Rated power (W)$$

$$R = Nominal resistance (\Omega)$$

#### Rated Voltage

Resistance Range:  $\geq 1\Omega$ 

Rated Voltage: The resistor shall have a DC continuous working voltage or a RMS AC continuous working voltage at commercial-line frequency and wave form corresponding to the power rating, as determined formula as following:

$$V = \text{Rated voltage (V)}$$

$$P = \text{Rated power (W)}$$

$$R = \text{Nominal resistance } (\Omega)$$



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# ■ Reliability Test and Requirement

Test Item	Test Method	Procedure	Requirements
Temperature Coefficient of Resistance (T.C.R)	JIS-C-5201-1 4.8 IEC-60115-1 4.8	At $25^{\circ}$ C / +125 $^{\circ}$ C, $25^{\circ}$ C is the reference temperature	Refer to Standard Electrical Specifications
Short Time Overload	JIS-C-5201-1 4.13 IEC-60115-1 4.13	5 times rated power whichever is less for 5 seconds.	±(1.0%+0.001Ω)
Insulation Resistance	JIS-C-5201-1 4.6 IEC-60115-1 4.6	Applied 100VDC for 1 minute.	<u>≥</u> 10GΩ
Dielectric Withstanding Voltage	JIS-C5201-1 4.7	Applied 500VAC for 1 minute.	No short or burned on the appearance.
Core Body Strength	JIS-C5201-1 4.15	Central part pressurizing force:10N,10 seconds	No broken
Solderability	JIS-C-5201-1 4.17 IEC-60115-1 4.17	245±5°C for 3 seconds.	>95% Coverage No Visual damage
Resistance to Soldering Heat	JIS-C-5201-1 4.18 IEC-60115-1 4.18	260±5°C for 10 seconds.	±(1.0%+0.001Ω) No Visual damage
Leaching	JIS-C-5201-1 4.18 IEC-60068-2-58 8.2.1	260±5°℃ for 30 seconds.	>95% Coverage No Visual damage
Rapid Change of Temperature	JIS-C-5201-1 4.19 IEC-60115-1 4.19	-55℃ to +155℃, 300 cycles	±(1.0%+0.001Ω) No Visual damage
Damp Heat with Load	JIS-C-5201-1 4.24 IEC-60115-1 4.24	40±2°C, 90~95% R.H. RCWV or Max. working current whichever is less for 1000 hrs with 1.5 hrs "ON" and 0.5 hr "OFF"	±(1.0%+0.001Ω)
Biased Humidity	MIL-STD-202 Method 103	1,000 hours; 85°C / 85% RH, 10% of operating power. Measurement at 24±4 hours after test conclusion.	±(1.0%+0.05Ω)
Load Life (Endurance)	JIS-C-5201-1 4.25 IEC-60115-1 4.25.1	70 $\pm$ 2°C, Rated power, or Max. working current whichever is less for 1000 hrs with 1.5 hrs "ON" and 0.5 hr "OFF".	±(1.0%+0.001Ω)
High Temperature Exposure	JIS-C-5201-1 4.23.2 IEC 60068-2-2	At +170±5°  for 1000 hours.	±(1.0%+0.001Ω)
Resistance to Solvent	JIS-C-5201-1 4.29	The tested resistor be immersed into isopropyl alcohol of 20~25℃ for 60 secs.  Then the resistor is left in the room for 48 hrs.	±(1.0%+0.001Ω) No Visual damage
Terminal Strength (SMD)	JIS-C5201-1 4.32 AEC Q200-006	Pressurizing force for 60 seconds 1206 and above: 17.7N	No broken
Bending Strength	JIS-C-5201-1 4.33 IEC-60115-1 4.33	Bending once for 5 seconds D: 1206 \ 1210 = 3mm 2010 \ 2512 = 2mm	±(1.0%+0.001Ω) No Visual damage

- ullet Temperature Coefficient of Resistance test to 55  $\,^{\circ}\text{C}\,$  is available on request
- We can also provide AEC-Q200 test reports if required by customers.

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#### Marking

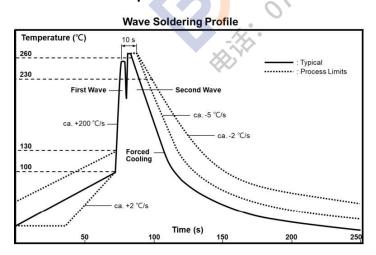
#### ■ TGL1206 ~ TGL2512 : 4 digit marking

First 3 digits are the significant figures, the 4th digit is the multiplier. "R"= decimal point. Examples:

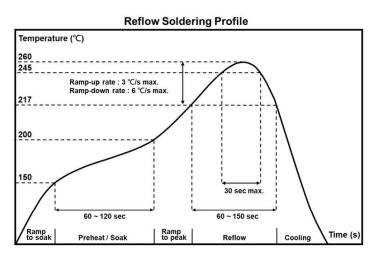
Resistance value	Code	Example
50 mΩ ~ 99 mΩ	R0XX	R050 = 0.05 Ω
100 mΩ ~ 999 mΩ	RXXX	R470 = 0.47 Ω
1 Ω ~ 9.9 Ω	XRXX	4R70 = 4.7 Ω
10 Ω ~ 50 Ω	XXRX	50R0 = 50 Ω

### Recommended Customer Soldering Parameters

#### Wave solder Temperature condition



#### Solder reflow Temperature condition





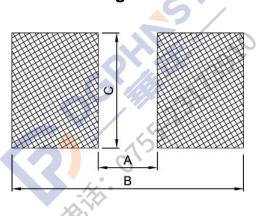
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- Rework temperature (hot air equipment): 350°C, 3~5seconds
- Recommended reflow methods

IR, vapor phase oven, hot air oven

If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

# ■ Recommend Land Pattern Design



Unit: mm

TYPE	A	В	С
TGL1206	2.20	4.20	1.80
TGL1210	2.00	4.40	2.70
TGL2010	3.80	6.60	2.70
TGL2512	4.90	8.10	3.40

## Plating Thickness

 $Ni: \geq \, 3 \mu m$ 

 $Sn(Tin): \ge 3\mu m$ 

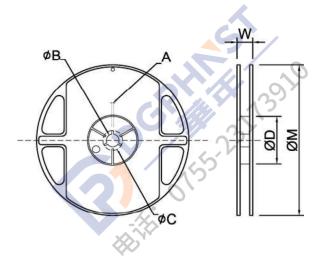


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# Appendix For SMD Chip Resistor

# Packaging Information

#### Reel Dimensions



Unit: mm

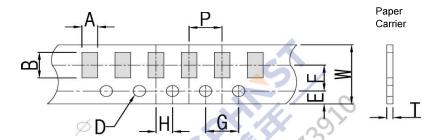
TYPE	SIZE		SIZE		Α	ΦВ	ФС	ΦD	W	ФМ
TGL1206	7"	5K/Reel	2.0±0.5	13.5±1.0	21±1.0	60±1.0	11.5±2.0	178±2.0		
TGL1210	7"	5K/Reel	2.0±0.5	13.5±1.0	21±1.0	60±1.0	11.5±2.0	178±2.0		
TGL2010	7"	4K/Reel	2.0±0.5	13.5±1.0	21±1.0	60±1.0	16.0±2.0	178±2.0		
TGL2512	7"	4K/Reel	2.0±0.5	13.5±1.0	21±1.0	60±1.0	16.0±2.0	178±2.0		



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# ■ Packaging Information

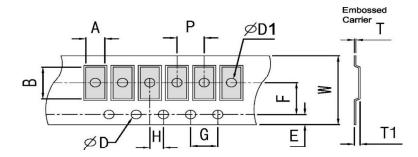
## ■ Tapping Specifications



Unit: mm

	Packaging	Type	Α	В	W	E	III	G	Η	T	ΦD	Р
	Paner Type	1206	1.90±0.2	3.05±0.2	8.0±0.2	1.75±0.1	3.5±0.05	4.0±0.1	2.0±0.05	0.75±0.1	1.50 <sup>+0.1</sup>	4.0±0.1
<b>\</b>	Paper Type	1210	2.85±0.2	3.05±0.2	8.0±0.2	1.75±0.1	3.5±0.05	4.0±0.1	2.0±0.05	0.75±0.1	1.50-0	4.0±0.1

#### **■** Embossed Dimensions



Unit: mm

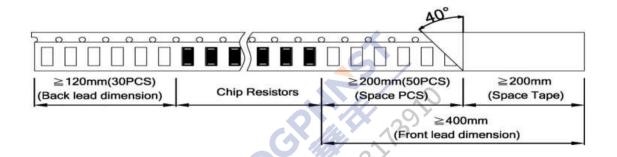
Packaging	Туре	A	В	W	Е	ш	G	Н	T	ΦD	ΦD1	T1	Р
Embossed	2010	2.80±0.2	5.60±0.2	12±0.1	1.75±0.1	5.5±0.05	4.0±0.1	2.0±0.05	0.23±0.1	1.50 <sup>+0.1</sup>	1.50±0.1	0.85±0.15	4.0±0.1
Туре	2512	3.40±0.2	6.70±0.2	12±0.1	1.75±0.1	5.5±0.05	4.0±0.1	2.0±0.05	0.23±0.1	1.50_0	1.50±0.1	0.85±0.15	4.0±0.1



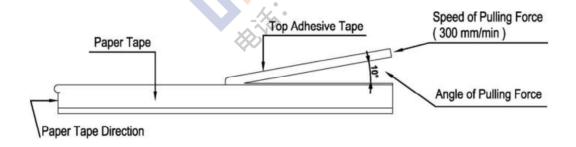
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## Packing Material Data / Storage Data

#### Front & Back Lead Dimensions

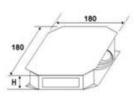


## ■ Top Adhesive Peel Off Strength:10~70g

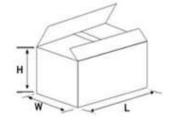


#### Package

Inner Box Size					
Reel	Size H(mm)				
1	13				
2	24				
3	36				
5	60				
10	113				



External Box Size									
Contain (Kpcs)	Length (mm)	Width (mm)	Height (mm)						
25K	180	180	60						
50K	180	180	110						
150K	430	200	200						
300K	400	400	200						



#### Storage Data :

Storage time at the environment temp: 25±5°C& humidity: 60±20% is valid for one year from the date of delivery.